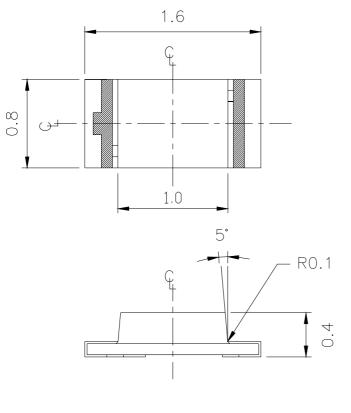
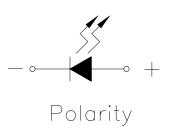
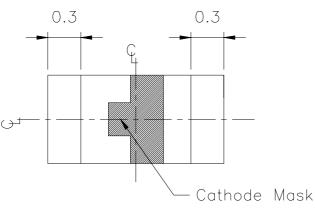
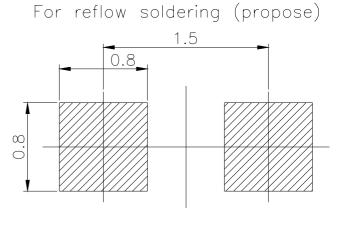
Package Outline Dimensions









Note: The tolerances unless mentioned is ± 0.1 mm, Unit

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Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	${ m I}_{ m F}$	25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	Ifp	60	mA	
Power Dissipation	Pd	60	mW	
Electrostatic Discharge(HBM)	ESD	2000	V	
Operating Temperature	Topr	- 40 ∼ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

-						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	11.5		28.5	mcd	
Viewing Angle	2 \theta 1/2		120		deg	
Peak Wavelength	λр		575		nm	
Dominant Wavelength	λd	569.5		577.5	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		20		nm	
Forward Voltage	V_{F}	1.75		2.35	V	
Reverse Current	I_R			10	μΑ	V _R =5V

Notes:

- 1.Tolerance of Luminous Intensity ±11%
- 2.Tolerance of Dominant Wavelength ±1nm
- 3.Tolerance of Forward Voltage ±0.1V

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Bin Range Of Dom. Wavelength

Group	Bin	Min	Max	Unit	Condition
A (C16	569.5	571.5	nm IF=20	
	C17	571.5	573.5		I- 20 A
	C18	573.5	575.5		IF=20mA
	C19	575.5	577.5		

Bin Range Of Luminous Intensity

Bin	Min	Max	Unit	Condition
L1	11.5	14.5		
L2	14.5	18.0	mcd	IF=20mA
M1	18.0	22.5		
M2	22.5	28.5		

Bin Range Of Forward Voltage

Group	Bin	Min	Max	Unit	Condition	
	0	1.75	1.95			
В	1	1.95	2.15	V	I _F =20mA	
	2	2.15	2.35			

Notes:

1. ToleLance of Luminous Intensity $\pm 11\%$

2.ToleLance of Dominant Wavelength ±1nm

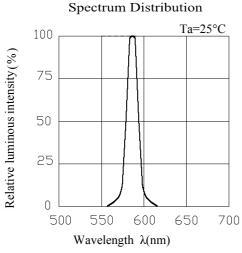
3.ToleLance of FoLwaLd Voltage ±0.1 V

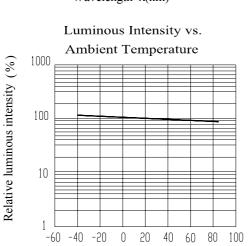
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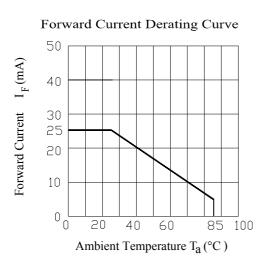


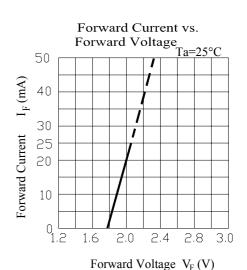
Typical ElectLo-Optical ChaLacteListics CuLves

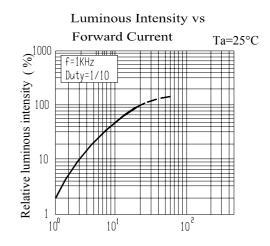


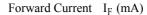


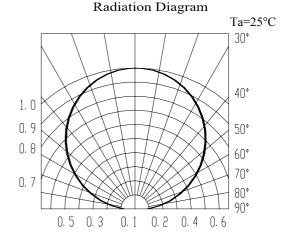
Ambient Temperature T_a(°C)











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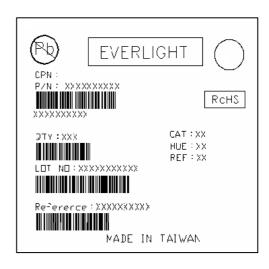


Label explanation

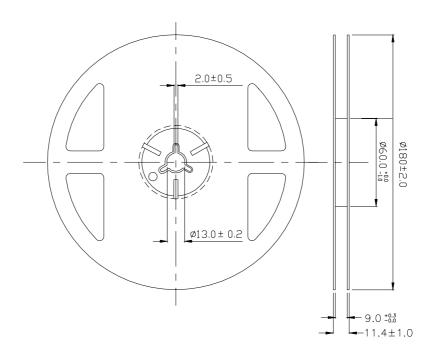
CAT: Luminous Intensity Lank

HUE: Dom. Wavelength Lank

LEF: FoLwaLd Voltage Lank



Leel Dimensions



Note: The toleLances unless mentioned is ± 0.1 mm, Unit = mm

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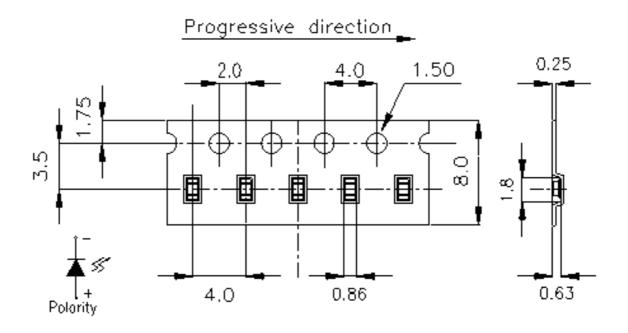
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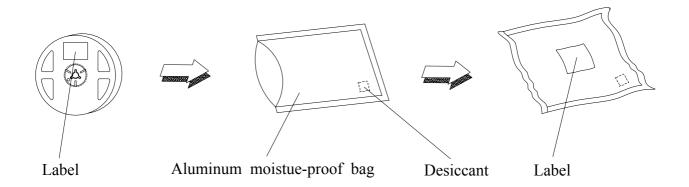


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The toleLances unless mentioned is ± 0.1 mm, Unit = mm

MoistuLe Lesistant Packaging



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Leliability Test Items And Conditions

The Leliability of pLoducts shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test HouLs/Cycle s	Sample Size	Ac/Le
1	Leflow SoldeLing	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	TempeLatuLe Cycle	H:+100°C 15min ∫ 5 min L:-40°C 15min	300 Cycles	22 PCS.	0/1
3	TheLmal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High TempeLatuLe StoLage	Temp. : 100°C	1000 HLs.	22 PCS.	0/1
5	Low TempeLatuLe StoLage	Temp. : -40°C	1000 HLs.	22 PCS.	0/1
6	DC OpeLating Life	$I_F = 20 \text{ mA}$	1000 HLs.	22 PCS.	0/1
7	High TempeLatuLe / High Humidity	85°C / 85%RH	1000 HLs.	22 PCS.	0/1

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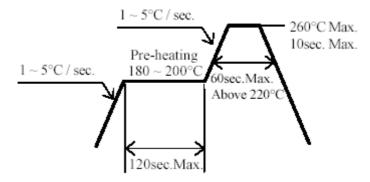
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PLecautions FoL Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
 - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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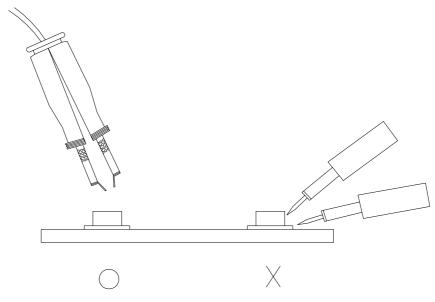


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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